

# N-Channel Super Junction Power MOSFET ${\ensuremath{\mathrm{III}}}$

### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

#### Features

- •New technology for high voltage device
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

### Application

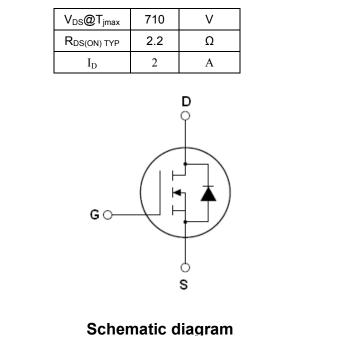
- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

#### Package Marking And Ordering Information

Device	Device Package	Marking
NCE65T2K4I	TO-251	NCE65T2K4I
NCE65T2K4K	TO-252	NCE65T2K4K

## Table 1. Absolute Maximum Ratings ( $T_c=25^{\circ}$ )

Parameter	Symbol	Value	Unit	
Drain-Source Voltage (VGs=0V)	Vds	650	V	
Gate-Source Voltage (VDs=0V) ,AC (f>1 Hz)	Vgs	±30	V	
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	2	А	
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	1.25	А	
Pulsed drain current (Note 1)	DM (pluse)	8	А	
Maximum Power Dissipation(Tc=25°C)	PD	21	W	
Derate above 25°C		0.168	W/°C	
Single pulse avalanche energy (Note2)	Eas	12	mJ	
Avalanche current <sup>(Note 1)</sup>	I <sub>AR</sub>	0.3	А	
Repetitive Avalanche energy , $t_{\text{AR}}$ limited by $T_{\text{jmax}}$ (Note 1)	E <sub>AR</sub>	0.06	mJ	



**TO-252** 

**TO-251** 



# NCE65T2K4I, NCE65T2K4K

Parameter	Symbol	Value	Unit
Drain Source voltage slope, $V_{DS} \leqslant$ 480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leqslant 480 V, I_{SD} < I_D$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55+150	°C
Table 2. Thermal Characteristic			

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	5.95	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	75	°C /W

### Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states				•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			10	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =70µA	3	3.5	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1A		2200	2400	mΩ
Dynamic Characteristics				•		
Input Capacitance	Clss			120		PF
Output Capacitance	Coss	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,		8		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		0.2		PF
Total Gate Charge	Qg	N/ 4001/1 0A		3.5	10	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =480V,I <sub>D</sub> =2A,		0.9		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		1.8		nC
Switching times				•		
Turn-on Delay Time	t <sub>d(on)</sub>			10		nS
Turn-on Rise Time	tr	V <sub>DD</sub> =380V,I <sub>D</sub> =1A,		9		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> =10Ω,V <sub>GS</sub> =10V		56		nS
Turn-Off Fall Time	t <sub>f</sub>	-		11		nS
Source- Drain Diode Characteristics				•		
Source-drain current(Body Diode)	I <sub>SD</sub>	T 05%0			2	А
Pulsed Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>C</sub> =25°C			8	А
Forward On Voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =2A,V <sub>GS</sub> =0V		1	1.3	V
Reverse Recovery Time	t <sub>rr</sub>			170		nS
Reverse Recovery Charge	Q <sub>rr</sub>	Tj=25°C,I <sub>F</sub> =1A,di/dt=100A/µs		0.26		uC
Peak reverse recovery current	Irrm	1		3		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

**2**. Tj=25°C,VDD=50V,VG=10V, R<sub>G</sub>=25Ω



# **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)**

### Figure1. Safe operating area



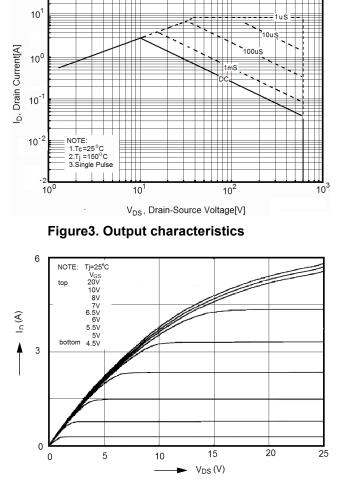
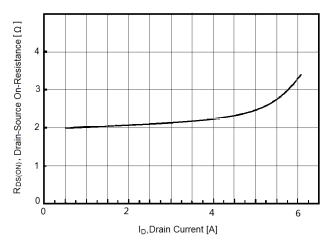
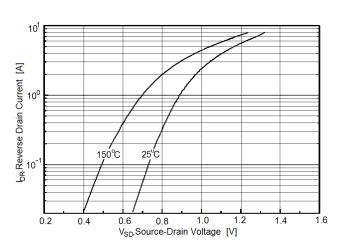
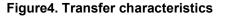


Figure5. Static drain-source on resistance







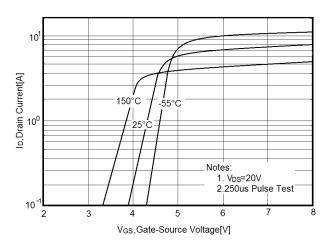
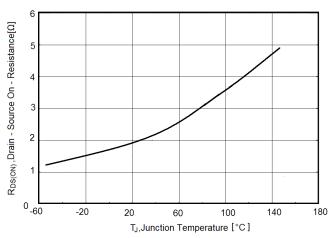


Figure6. R<sub>DS(ON)</sub> vs Junction Temperature





#### Figure7. BV<sub>DSS</sub> vs Junction Temperature

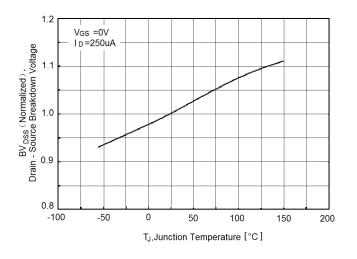


Figure9. Transient Thermal Impedance

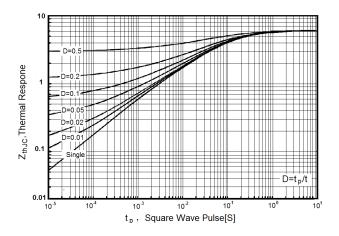
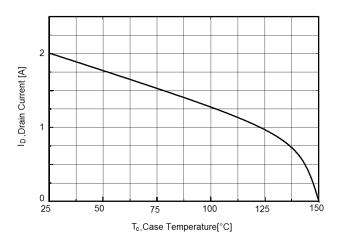


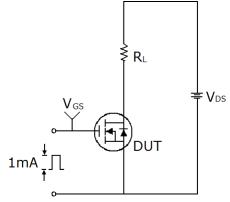
Figure8. Maximum I<sub>D</sub> vs Junction Temperature

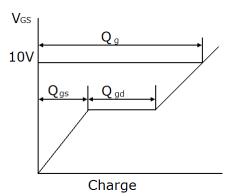




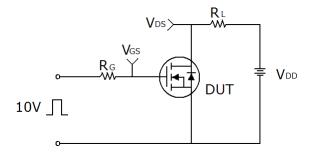
# Test circuit

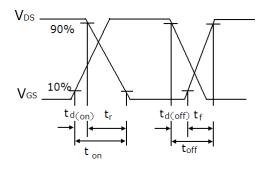
1) Gate charge test circuit & Waveform



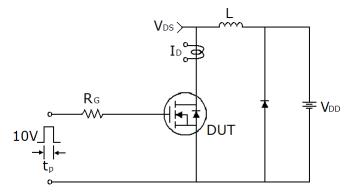


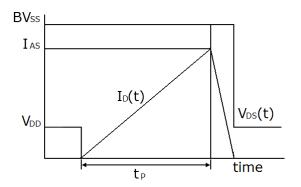
2) Switch Time Test Circuit:





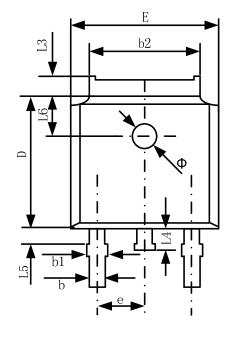
## 3) Unclamped Inductive Switching Test Circuit & Waveforms

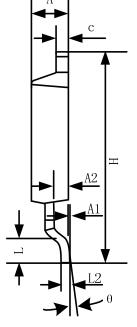


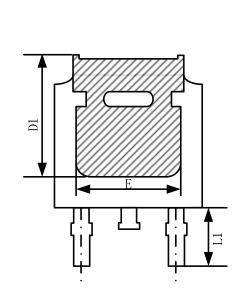




# **TO-252-2 Package Information**



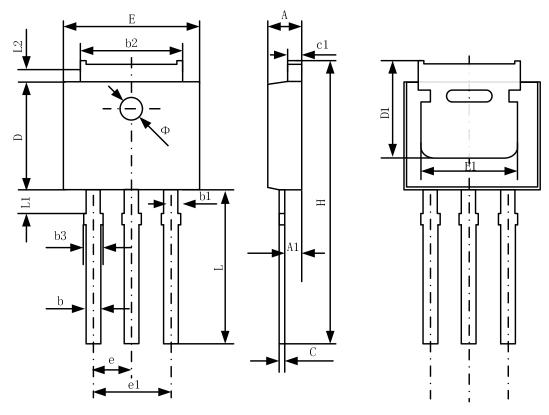




Symbol	Dimensions	In Millimeters	<b>Dimensions In Inches</b>		
Symbol	Min.	Max.	Min.	Max.	
А	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
E	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.90 REF		0.114 REF		
L2	0.508 BSC		0.020	) BSC	
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Φ	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	



# **TO-251 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	



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